

Dual Buffer with Open-drain Output

Features

- Wide Supply Voltage Range from 1.65 V to 5.5 V
- I/O Tolerance Inputs to 5.5 V
- All Inputs with Schmitt-Trigger Action
- CMOS Low Power Dissipation
- I_{OFF} Supports Partial Power-down Protection
- ESD Protection: ±4-kV HBM Model, ±1-kV CDM Model
- Latch-up Performance Exceeds 100 mA per JESD 78, Class II

Applications

- Computing
- Tablet PC
- Television
- Wearable Device
- Server
- Industrial Equipment

Description

The T74L2G07 is a dual Open-drain output buffer with V_{CC} supply from 1.65 V to 5.5 V. Schmitt-Trigger action with slower rise-and-fall times and better noise immunity. I_{OFF} circuits can prevent backflow current during power-down, thus supporting partial power-down protection.

The T74L2G07 is available in the SOT363 package and is characterized from -40°C to 125°C.

Device Table

Device	Package	Body Size
T74L2G07-SC6R	SOT363	2.1 mm x 1.25 mm

Typical Application Circuit

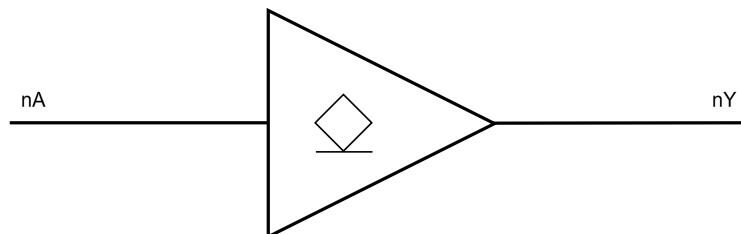


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Revision History

Date	Revision	Notes
2025-04-24	Rev.Pre.0	Initial version.
2025-10-20	Rev.A.0	Released version.

Pin Configuration and Functions

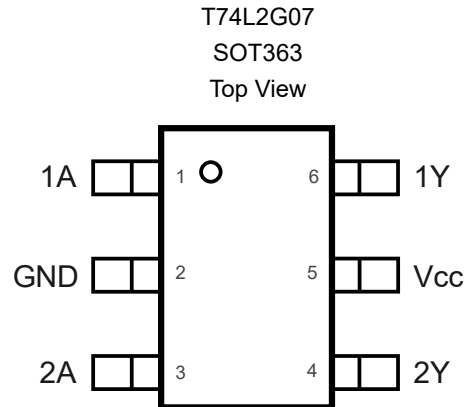


Table 1. Pin Functions

Pin No.	Name	I/O	Description
1	1A	I	Input 1A
2	GND	Power	Ground
3	2A	I	Input 2A
4	2Y	O	Output 2Y
5	V _{CC}	Power	Supply pin
6	1Y	O	Output 1Y

Function Table

Table 2. Truth Table

Input	Output
A	Y
L	L
H	Z

(1) H = High voltage level.

(2) L = Low voltage level.

(3) X = Don't care.

(4) Z = High-impedance

Specifications

Absolute Maximum Ratings ⁽¹⁾

Parameter		Min	Max	Unit
V _{CC}	Supply Voltage	−0.5	6.5	V
V _I	Input Voltage ⁽²⁾	−0.5	6.5	V
V _O	Output Voltage, in Power-off Mode ⁽²⁾	−0.5	6.5	V
V _O	Output Voltage, in Active Mode ⁽²⁾	−0.5	6.5	V
I _O	Continuous Output Current		50	mA
I _{IK}	Input Clamp Current, V _I < 0	−50		mA
I _{OK}	Output Clamp Current, V _O < 0	−50		mA
	Continuous Current through V _{CC} or GND	−100	100	mA
T _J	Junction Temperature		150	°C
T _{STG}	Storage Temperature	−65	150	°C

(1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) The minimum input and output voltage ratings may be exceeded if the input and output current ratings are observed.

ESD, Electrostatic Discharge Protection

Symbol	Parameter	Condition	Minimum Level	Unit
HBM	Human Body Model ESD	ANSI/ESDA/JEDEC JS-001, all pins ⁽¹⁾	±4,000	V
CDM	Charged Device Model ESD	ANSI/ESDA/JEDEC JS-002, all pins ⁽²⁾	±1,000	V

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

Recommended Operating Conditions

All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation.

Parameter		Min	Typ	Max	Unit
V _{CC}	Supply Voltage	1.65		5.5	V
V _I	Input Voltage	0		5.5	V
V _O	Output Voltage	0		5.5	V
T _A	Ambient Temperature	−40		125	°C
Δt/ΔV	Input Transition Rise-and-Fall Rate, V _{CC} = 1.65 V to 2.7 V			20	ns/V
	Input Transition Rise-and-Fall Rate, V _{CC} = 2.7 V to 5.5 V			10	ns/V

Thermal Information

Package Type	θ_{JA}	θ_{JC}	Unit
SOT363	230.1	62.7	°C/W

Electrical Characteristics – DC Parameter

All test conditions: $T_A = -40^{\circ}\text{C}$ to 125°C , all typical values are measured at $T_A = 25^{\circ}\text{C}$, unless otherwise noted.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{IH}	High-Level Input Voltage	$V_{CC} = 1.65\text{ V to }1.95\text{ V}$	$0.7V_{CC}$			V
		$V_{CC} = 2.3\text{ V to }2.7\text{ V}$	1.7			V
		$V_{CC} = 2.7\text{ V to }3.6\text{ V}$	2			V
		$V_{CC} = 4.5\text{ V to }5.5\text{ V}$	$0.7V_{CC}$			V
V_{IL}	Low-Level Input Voltage	$V_{CC} = 1.65\text{ V to }1.95\text{ V}$			$0.3V_{CC}$	V
		$V_{CC} = 2.3\text{ V to }2.7\text{ V}$			0.7	V
		$V_{CC} = 2.7\text{ V to }3.6\text{ V}$			0.8	V
		$V_{CC} = 4.5\text{ V to }5.5\text{ V}$			$0.3V_{CC}$	V
V_{OL}	Low-Level Output Voltage	$I_{OL} = 100\text{ }\mu\text{A};$ $V_{CC} = 1.65\text{ V to }5.5\text{ V}$			0.1	V
		$I_{OL} = 4\text{ mA}; V_{CC} = 1.65\text{ V}$			0.7	V
		$I_{OL} = 8\text{ mA}; V_{CC} = 2.3\text{ V}$			0.45	V
		$I_{OL} = 12\text{ mA}; V_{CC} = 2.7\text{ V}$			0.6	V
		$I_{OL} = 24\text{ mA}; V_{CC} = 3\text{ V}$			0.8	V
		$I_{OL} = 32\text{ mA}; V_{CC} = 4.5\text{ V}$			0.8	V
I_I	Input Leakage Current	$V_I = \text{GND or }5.5\text{ V};$ $V_{CC} = 0\text{ V to }5.5\text{ V}$	-1	± 0.1	1	μA
I_{OZ}	OFF-state output current	$V_I = V_{IH};$ $V_O = V_{CC} \text{ or } \text{GND}; V_{CC} = 5.5\text{ V}$	-1	± 0.1	1	μA
I_{OFF}	Power-off Leakage Current	$V_I \text{ or } V_O = 5.5\text{ V};$ $V_{CC} = 0\text{ V}$	-1	± 0.1	1	μA
I_{CC}	Supply Current	$V_I = \text{GND or }V_{CC}; I_O = 0\text{ A};$ $V_{CC} = 1.65\text{ V to }5.5\text{ V}$		0.1	2	μA
ΔI_{CC}	Additional Supply Current	$V_I = V_{CC} - 0.6\text{ V}; I_O = 0\text{ A};$ $V_{CC} = 2.3\text{ V to }5.5\text{ V}$		0.1	10	μA
$C_I^{(1)}$	Input Capacitance			2.1		pF

(1) Spec limit is based on bench characterization and design simulation, not tested in production.

Electrical Characteristics – AC Parameter

All test conditions: $T_A = -40^{\circ}\text{C}$ to 125°C , all typical values are measured at $T_A = 25^{\circ}\text{C}$, unless otherwise noted.

Symbol ⁽¹⁾	Parameter	Conditions	Min	Typ	Max	Unit
t_{PD} ⁽²⁾	Propagation Delay at 30-pF C_{LOAD}	$C_{LOAD} = 30\text{ pF};$ $V_{CC} = 1.65\text{ V to }1.95\text{ V}$	4.8	8.9	15	ns
		$C_{LOAD} = 30\text{ pF};$ $V_{CC} = 2.3\text{ V to }2.7\text{ V}$	2.1	5.8	9.3	ns
	Propagation Delay at 50-pF C_{LOAD}	$C_{LOAD} = 50\text{ pF};$ $V_{CC} = 2.7\text{ V}$	2.6	5.6	9	ns
		$C_{LOAD} = 50\text{ pF};$ $V_{CC} = 3\text{ V to }3.6\text{ V}$	2	4.8	8.1	ns
		$C_{LOAD} = 50\text{ pF};$ $V_{CC} = 4.5\text{ V to }5.5\text{ V}$	1.6	4.2	6.2	ns
C_{PD} ⁽³⁾	Power Dissipation Capacitance	$f = 10\text{ MHz};$ $V_{CC} = 3.3\text{ V}$		2		pF

(1) Spec limit is based on bench characterization and design simulation, not tested in production.

(2) t_{PD} is the same as t_{PLZ} and t_{PZL} .

(3) C_{PD} is used to determine the dynamic power dissipation (PD in μW).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$$

Where:

f_i = Input frequency in MHz;

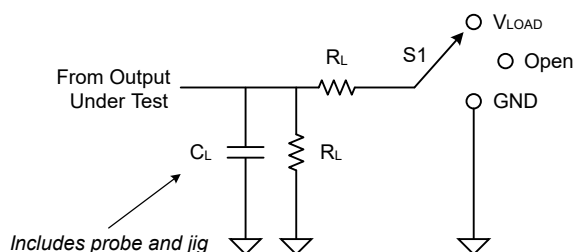
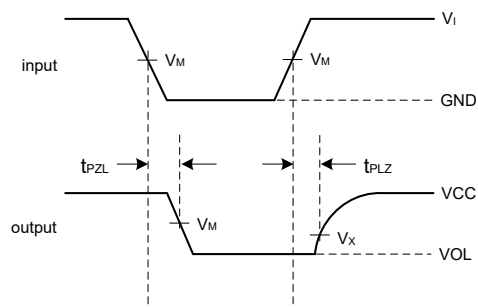
f_o = Output frequency in MHz;

C_L = Output load capacitance in pF;

V_{CC} = Supply voltage in Volts;

N = Number of inputs switching;

$\Sigma(C_L \times V_{CC}^2 \times f_o)$ = Sum of the outputs.

Parameter Measurement Waveforms

Figure 1. Timing Measurement Load Circuit

Figure 2. Propagation Delay Times
Table 3. Test Data

V_{CC}	Inputs		C_L	R_L	V_M	V_X	S1
	V_I	t_r/t_f					t_{PZL}/t_{PLZ}
1.65 V to 1.95 V	V_{CC}	≤ 2 ns	30 pF	1 k Ω	$0.5V_{CC}$	$V_{OL} + 0.15$ V	$2V_{CC}$
2.3 V to 2.7 V	V_{CC}	≤ 2 ns	30 pF	500 Ω	$0.5V_{CC}$	$V_{OL} + 0.15$ V	$2V_{CC}$
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	1.5 V	$V_{OL} + 0.3$ V	6 V
3 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	1.5 V	$V_{OL} + 0.3$ V	6 V
4.5 V to 5.5 V	V_{CC}	≤ 2.5 ns	50 pF	500 Ω	$0.5V_{CC}$	$V_{OL} + 0.3$ V	$2V_{CC}$

Application and Implementation

Note

Information in the following application sections is not part of the 3PEAK's component specification and 3PEAK does not warrant its accuracy or completeness. 3PEAK's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

Typical Application

Figure 3 shows the typical application schematic.

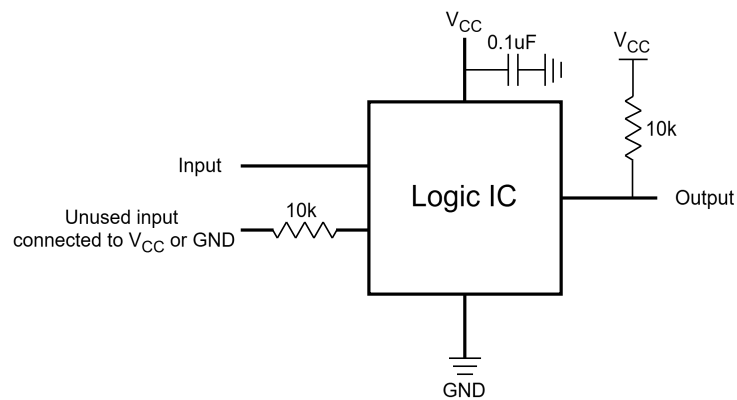
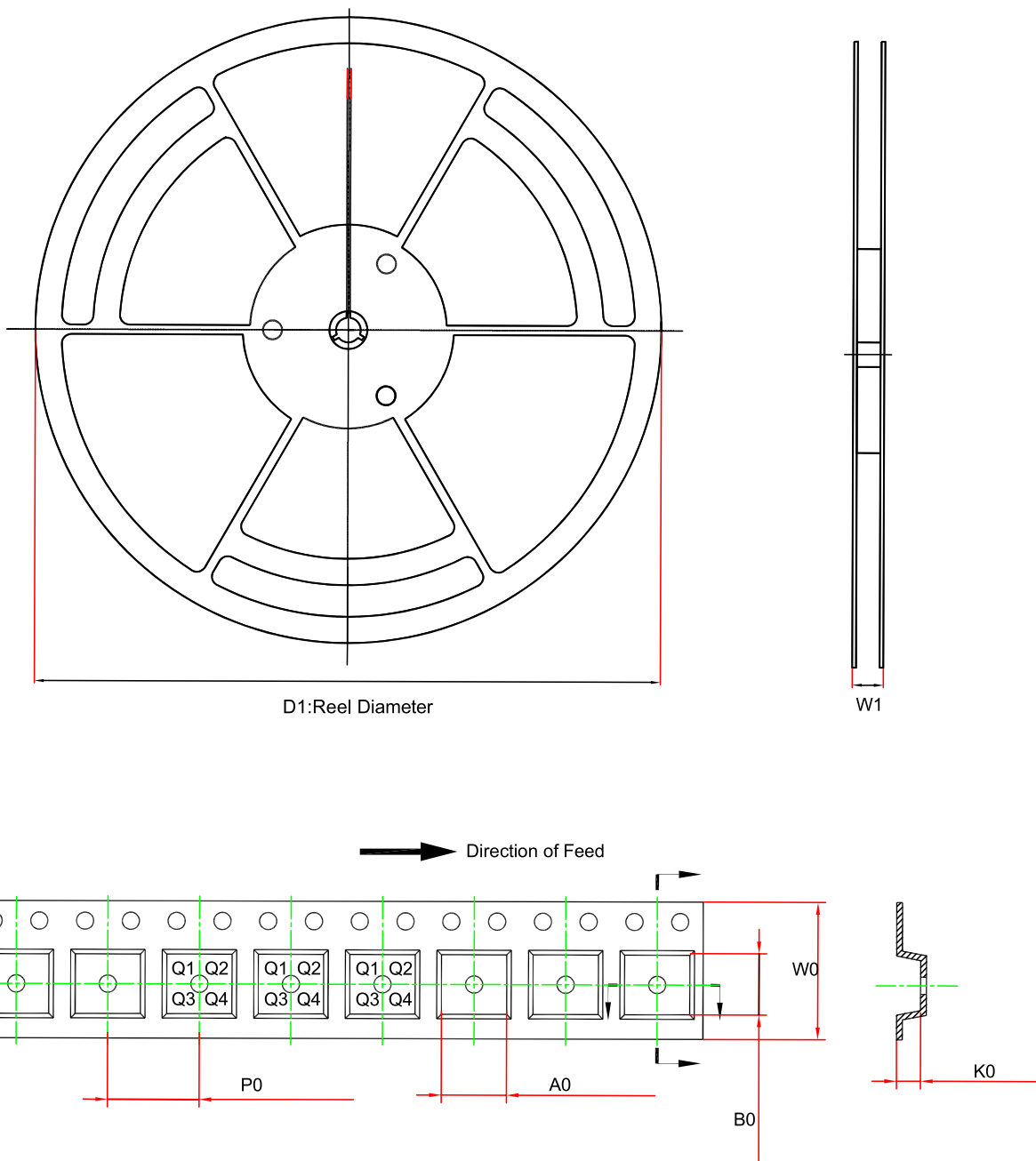


Figure 3. Typical Application Circuit

Tape and Reel Information



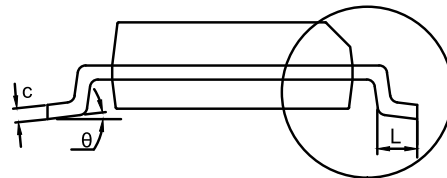
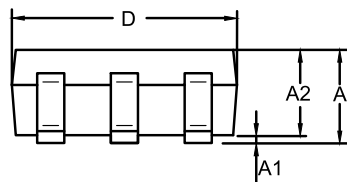
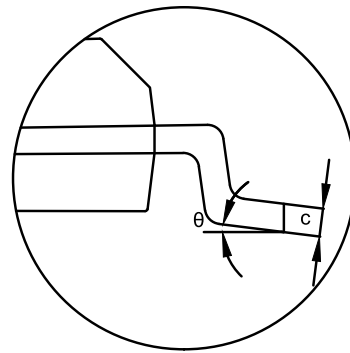
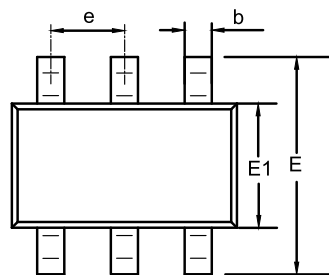
Order Number	Package	D1 (mm)	W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	W0 (mm)	Pin1 Quadrant
T74L2G07-SC6R	SOT363	178	12.1	2.4	2.5	1.2	4	8	Q3

Package Outline Dimensions

SOT363

Package Outline Dimensions

SC6(SOT363-6-A)



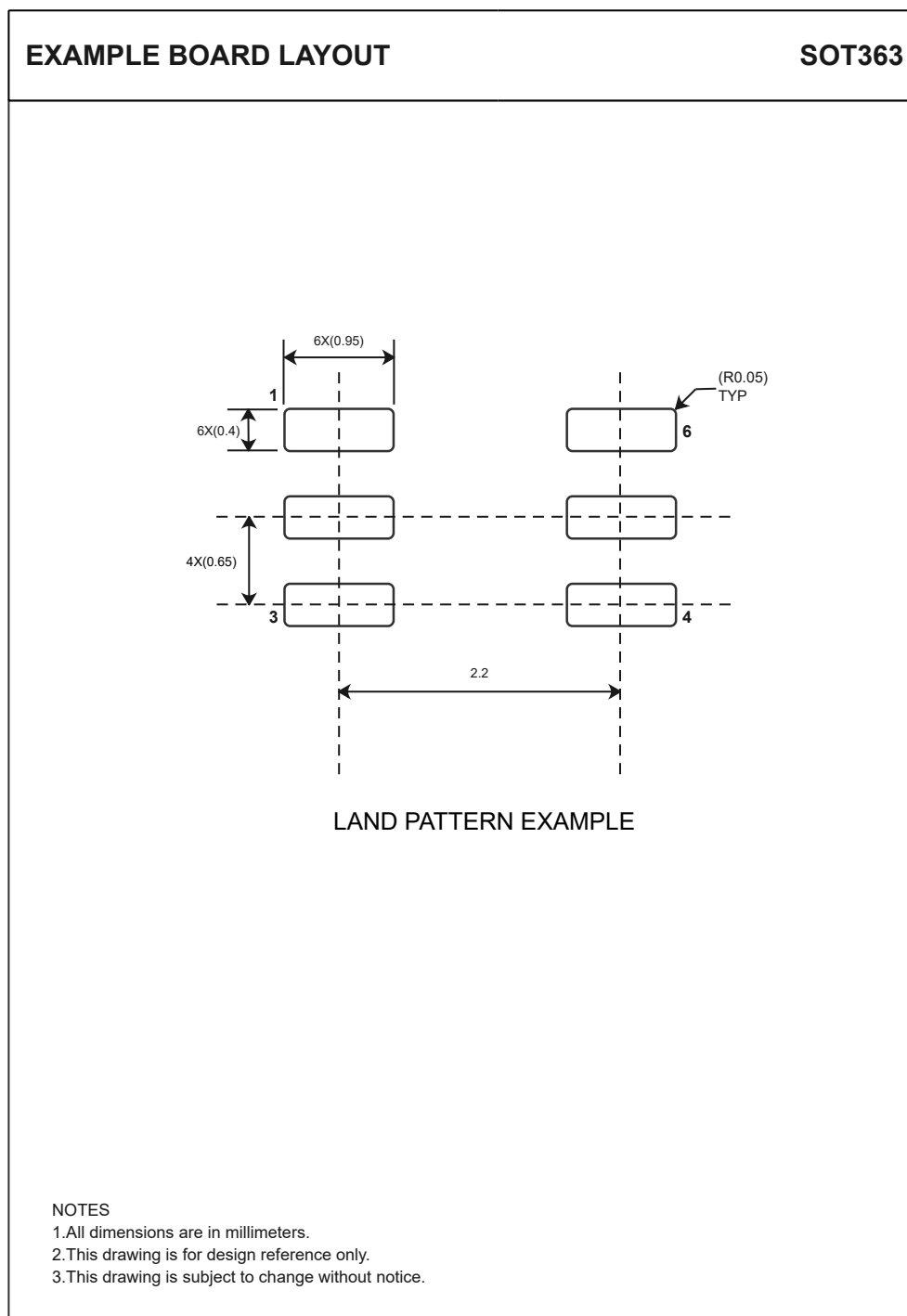
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	0.850	1.100	0.033	0.043
A1	0.000	0.100	0.000	0.004
A2	0.800	1.000	0.031	0.039
b	0.150	0.350	0.006	0.014
c	0.080	0.230	0.003	0.009
D	2.000	2.200	0.079	0.087
E	2.150	2.450	0.085	0.096
E1	1.150	1.350	0.045	0.053
e	0.650 BSC		0.026 BSC	
L	0.260	0.460	0.010	0.018
θ	0	8°	0	8°

NOTES

1. Do not include mold flash or protrusion.
2. This drawing is subject to change without notice.

Land Pattern

SOT363



Order Information

Order Number	Operating Temperature Range	Package	Marking Information	MSL	Transport Media, Quantity	Eco Plan
T74L2G07-SC6R	-40 to 125°C	SOT363	V7	MSL3	Tape and Reel,3000	Green

Green: 3PEAK defines "Green" to mean RoHS compatible and free of halogen substances.

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